

Title (en)

METHOD FOR SHIELDING AT LEAST THE UPPER PART OF A RADIOPHONIC MODULE, AND CORRESPONDING RADIOPHONIC MODULE

Title (de)

VERFAHREN ZUR ABSCHIRMUNG ZUMINDEST DES OBERTEILS EINES FUNKÜBERTRAGUNGSSYSTEMS UND ENTSPRECHENDES FUNKÜBERTRAGUNGSSYSTEM

Title (fr)

PROCEDE DE BLINDAGE D'AU MOINS LA PARTIE SUPERIEURE D'UN MODULE DE RADIOPHONIE, ET MODULE DE RADIOPHONIE CORRESPONDANT

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Application

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Abstract (en)

[origin: WO0182671A1] The invention concerns a method for shielding at least the upper part of a radiophonic module (1), said module being designed to be transferred on a mother board (5) and including components mounted on a printed circuit and providing at least one of the following functions. RF processing, digital processing and analog processing. The inventive method is characterised in that it comprises the following steps: coating at least the upper part (2) of said radiophonic module with a resin and adding an electrically conductive layer at the surface of the resin. The invention also concerns a radiophonic module whereof at least the upper part is thus shielded.

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